RoHS COMPLIANT

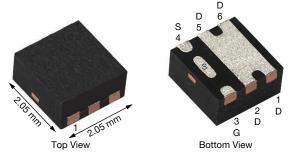
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Vishay Siliconix

N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^{b, c}	Q _g (TYP.)		
30	0.0200 at V _{GS} = 10 V	10.1	5.6		
	0.0240 at V_{GS} = 4.5 V	9.2	5.0		

PowerPAK[®] SC-70-6L Single



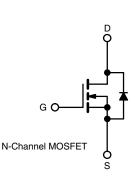
FEATURES

- TrenchFET[®] power MOSFET
- Thermally enhanced PowerPAK[®] SC-70 package - Small footprint area
- 100 % UIS tested

 Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

Load Switch



Marking Code: A L

Ordering Information: SiA432DJ-T1-GE3 (Lead (Pb)-free and Halogen-free) SiA432DJ-T4-GE3 (Lead (Pb)-free and Halogen-free)

PARAMETER Drain-Source Voltage Gate-Source Voltage		SYMBOL	LIMIT	UNIT
		V _{DS}	30	V
		V _{GS}	± 20	
	T _C = 25 °C		12 ^a	
	T _C = 70 °C		12 ^a	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	10.1 ^{b, c}	
	T _A = 70 °C		8.1 ^{b, c}	•
Pulsed Drain Current		I _{DM}	30	A
	T _C = 25 °C		12 ^a	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.9 b, c	
Single-Pulse Avalanche Current		I _{AS}	15.5	
Single-Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	12	mJ
	T _C = 25 °C		19.2	
	T _C = 70 °C		12.3	
Maximum Power Dissipation	T _A = 25 °C	PD	3.5 ^{b, c}	W
	T _A = 70 °C		2.2 ^{b, c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150	°C
Soldering Recommendations (Peak Temperature) ^{d, e}		Ť	260	

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	28	36	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	5.3	6.5	-0/w	

Notes

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: Manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 80 °C/W.

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SiA432DJ

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	30	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 ··· A	-	35	-	mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μΑ	-	-5.6	-	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	-	3	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μA
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	20	-	-	Α
Drain-Source On-State Resistance ^a	5	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6 \text{ A}$	-	0.0158	0.0200	Ω
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	-	0.0190	0.0240	
Forward Transconductance ^a		$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 6 \text{ A}$	-	22	-	S
Dynamic ^b					•	
Input Capacitance	C _{iss}		-	800	-	pF
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	-	115	-	
Reverse Transfer Capacitance	C _{rss}			54	-	
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	13	20	nC
			-	5.6	9	
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	2	-	
Gate-Drain Charge	Q _{gd}		-	1.4	-	
Gate Resistance	Rg	f = 1 MHz	-	3	-	Ω
Turn-On Delay Time	t _{d(on)}		-	15	25	-
Rise Time	tr	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{L}} = 1.9 \Omega$	-	11	17	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ 8 A, V_{GEN} = 4.5 V, R_g = 1 Ω	-	15	25	
Fall Time	t _f		-	10	15	
Turn-On Delay Time	t _{d(on)}		-	8	15	ns -
Rise Time	tr	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{L}} = 1.9 \Omega$	-	8	15	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 8 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$	-	15	25	
Fall Time	t _f		-	8	15	
Drain-Source Body Diode Characteristic	cs					
Continuous Source-Drain Diode Current	Is	T _C = 25 °C	-	-	12	
Pulse Diode Forward Current	I _{SM}		-	-	30	A
Body Diode Voltage	V _{SD}	$I_{\rm S} = 5$ A, $V_{\rm GS} = 0$ V	-	0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}		-	16	30	ns
Body Diode Reverse Recovery Charge	Q _{rr}	 I _F = 8 A, dl/dt = 100 A/μs, T _J = 25 °C		8	15	nC
Reverse Recovery Fall Time	ta			9.8	-	
Reverse Recovery Rise Time	t _b	1	-	6.2	-	ns

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

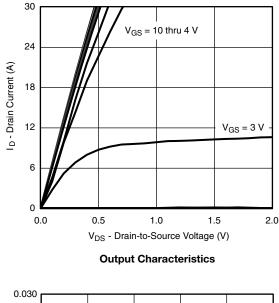
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

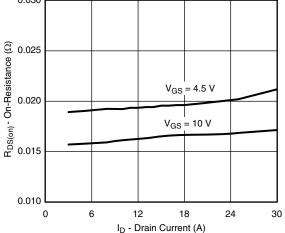
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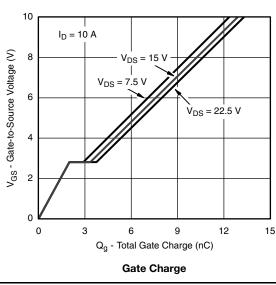
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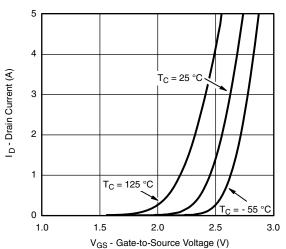
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



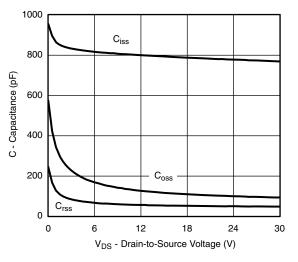


On-Resistance vs. Drain Current and Gate Voltage

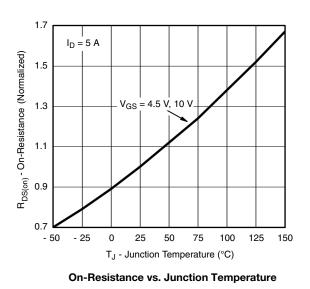




Transfer Characteristics







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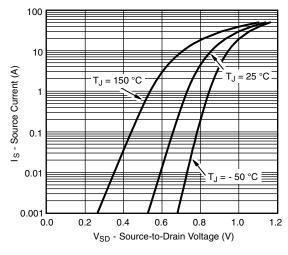
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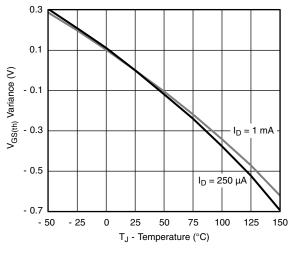


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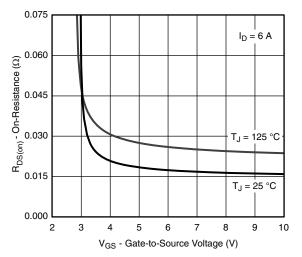
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



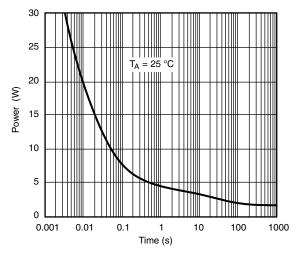
Source-Drain Diode Forward Voltage



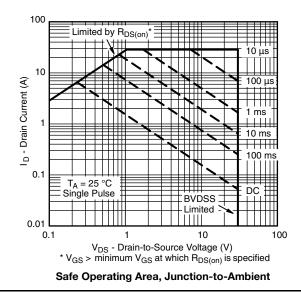




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)



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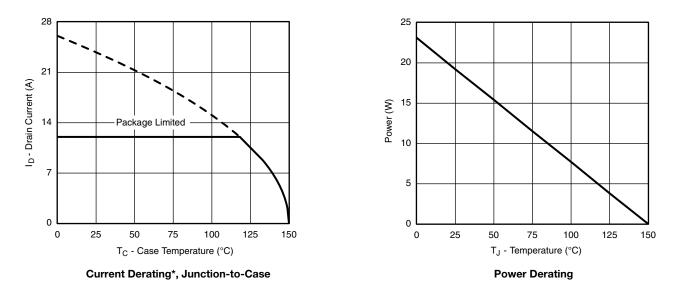
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

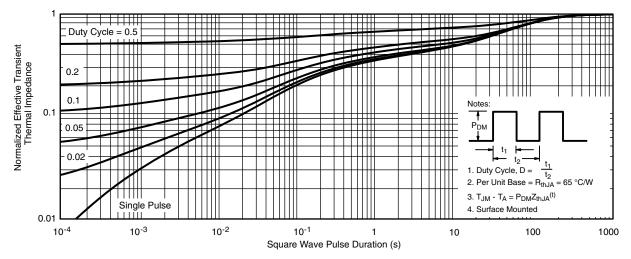


* The power dissipation P_D is based on $T_{J (max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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PowerPAK[®] SC70-6L

VISHA

b PIN2 PIN1 PIN3 _ ₹



b

PIN3

__ ₿

PIN2

PIN1

¥

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¹



RECOMMENDED PAD LAYOUT FOR PowerPAK[®] SC70-6L Single



Dimensions in mm/(Inches)

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